

Available online at www.sciencedirect.com



Journal of the European Ceramic Society 25 (2005) 2779-2783



www.elsevier.com/locate/jeurceramsoc

Low sintering temperature of MgTiO₃ for type I capacitors

Jerome Bernard*, Florent Belnou, David Houivet, Jean-Marie Haussonne*

LUSAC (EA 2607), University of Caen, BP 78, 50130 Cherbourg Octeville, France

Available online 16 April 2005

Abstract

Magnesium titanate MgTiO₃ is a well-known compound for type I multilayer ceramic capacitors. Nevertheless, the sintering temperature of the pure ilmenite MgTiO₃ is around 1350 °C. Such a high sintering temperature together with the high sensitivity of the dielectric material to reduction when heated in a low-oxygen containing atmosphere implies that MgTiO₃-based MLCC include palladium-rich inner electrodes. The high level of variation of both the costs of Pd and Ag justifies research leading to the use of cheaper metals such as silver or base metals such as nickel or copper. When using low-melting temperature metals (silver melts at 960 °C and copper at 1085 °C), the sintering temperature of the dielectric material has to be lowered. We report here on our investigations into the use of fluorine containing additives for the reducing of the sintering temperature of magnesium titanate, showing the ability of this material to be sintered at temperatures much lower than 1000 °C. Both dielectric and electric properties of such ceramics are compatible with type I capacitors requirements. © 2005 Elsevier Ltd. All rights reserved.

Keywords: Capacitors; Dielectric properties; Sintering; Titanates; Halides

1. Introduction

Although much R&D has been devoted to the production of type II multilayer ceramic capacitors with non-noble metals electrodes¹⁻⁴ for more than 30 years, only few reports have been published related to the solving of the same problem with type I capacitors. Yet, the economic problems due to the high and variable cost of the noble metals, palladium and silver, classically used to form the inner electrodes, is exactly the same in both families of capacitors.

Another problem has to be solved together: as many applications of type I MLCC exclude the use of magnetic materials, the use of nickel inner electrodes is thus prohibited and copper electrodes have to be considered. Copper electrodes have another advantage: thanks to their high electrical conductivity, they allow the use of these capacitors at very high frequencies. Yet an important technological problem remains, that is the low-melting temperature of copper, $1085 \,^{\circ}$ C, which makes the sintering temperature to be much lower than $1000 \,^{\circ}$ C.

jm.haussonne.lusac@chbg.unicaen.fr (J.-M. Haussonne).

Magnesium titanate MgTiO₃, with its ilmenite structure, is one of the materials classically used for the making of noble metal electrodes MLCC. It has been previously demonstrated that it was possible to sinter it at 1350 °C in a slightly reducing atmosphere (wet N₂ + 1 vol.% H₂) when Ti⁴⁺ in the B site of the ilmenite structure was substituted with equal at% amounts of W⁶⁺ and Mn²⁺ acting as the couple donor/acceptor in the same way as previously stated for type II BaTiO₃-based compositions.^{5,6}

This temperature is quite compatible with the use of nickel electrodes, but is totally inadequate for the use of copper electrodes. Furthermore, when MgTiO₃ is co-sintered with nickel, the EDX analysis performed at the Ni/MgTiO₃ interface shows that some reaction occurs between these two materials.⁶ It is thus important to be able to lower the sintering temperature of magnesium titanate in order to consider its use together with copper inner electrodes.

Although the structures of the perovskite BaTiO₃ and the ilmenite MgTiO₃ are quite different, we were prompted at the beginning of this work by the conclusions of previous studies that concluded to the ability of sintering barium titanate or other compounds such as the perovskite SrTiO₃, the relaxors PMN/PFN or titanium oxide at temperatures lower than $1000 \,^{\circ}C.^{7}$

^{*} Corresponding authors. Tel.: +33 2 33 01 42 33; fax: +33 2 33 01 41 35. *E-mail addresses:* bernard@chbg.unicaen.fr (J. Bernard),

 $^{0955\}text{-}2219/\$$ – see front matter @ 2005 Elsevier Ltd. All rights reserved. doi:10.1016/j.jeurceramsoc.2005.03.139

Particularly in the case of BaTiO₃, lithium compounds additions, preferably LiF or BaLiF₃, to barium titanate with a controlled stoichiometry, were demonstrated to be particularly efficient. Two different and independent mechanisms have been demonstrated that, acting as well alone or together, allow sintering at low temperatures, lower than 1000 °C.

The first one involves only lithium substitutions to titanium. Lithium ion Li⁺, thanks to its ionic radius, can easily substitute Ti⁴⁺ with the consequence of anionic vacancies in the "BO₃" network that lead to the formation of extended defects such as the elimination of oxygen rows in the $\langle 1 \ 1 \ 0 \rangle$ direction or along $\langle 1 \ 0 \ 0 \rangle$ and the formation of TiO₅ pyramids. Both types of extended defects are supposed to exist together, leading to easier diffusion and, thus, lower temperature densification. The formula of the material can then be written Ba(Ti_{1-x}Li_x)O_{3-3x/2}.

The second one is to be considered only when lithium is introduced together with fluorine: Li^+ ions substitute Ti^{4+} and F^- ions O^{--} in the perovskite cell, leading to the formation of a solid solution between BaTiO₃ and BaLiF₃ that can be expressed as BaTi_{1-x}Li_xO_{3-3x}F_{3x}. BaLiF₃ melts incongruently at 750 °C, and thus the solid solution can densify at a low temperature.

Yet the structure of the ilmenite MgTiO₃ is quite different to that of the BaTiO₃ perovskite. In both structures, Ti⁴⁺ ions are 6-coordinated. For the A site of the two structures, large Ba²⁺ ions possess a 12 coordinence while the smaller Mg²⁺ ions are 6-coordinated. Furthermore, although the MgLiF₃ compound is supposed theoretically to exist, it has never been experimentally synthesized and observed. So, the analogy with the previous studies can be only related to the first mechanism, that is to say the possible introduction of Li in either the A or the B site of the ilmenite (but, due to the values of the ionic radius, preferably in the A site by substituting Mg), acting in both cases as an acceptor and, thus, being susceptible to lead to the formation of oxygen vacancies (Ti⁴⁺ = 0.605 Å, Mg²⁺ = 0.72 Å and Li⁺ = 0.74 Å).

2. Experimental procedure

The MgTiO₃ powders were synthesized by the classical solid-state route. The starting powders (MgO, TiO₂) were mixed together for 1 h in water by attrition milling (Dyno Mill KDLA, BACHOFEN, Switzerland) using 0.8 mm diameter yttried stabilized zircon balls (YTZ grinding media TOSOH). The powders were then calcined in air at 1000 °C during 1 h in order to form the ilmenite phase. The phase formation was controlled by X-ray diffraction. The diffraction patterns were collected using a SIEMENS 5005 diffractometer with Cu K α ($\lambda = 1.5405$ Å), in the range 15–85° (2 θ)). After calcination fluorine compounds was added and the powders were milled in a planetary agitator (Pulverisette FRITCH with agate bawl and balls). Densification behavior was studied by dilatometric measurements performed only in air on a TMA92 SETARAM dilatometer, with heating and cooling rates of 300 °C h⁻¹.

The different compositions were pressed at 2000 kg cm⁻² to obtain disks 10 mm in diameter and around 1.5 mm thick. The disks were fired in a moist $N_2 - 1\%$ H₂ reducing atmosphere, with heating and cooling rates of $150 \,^{\circ}$ C h⁻¹ and dwell time of 1 h.

The faces of the disks were metallized using the indium–gallium eutectic. The insulation resistances were measured in a dry atmosphere at 25 °C under a 1 V μ m⁻¹ DC bias (Sefelec (SIM 1000 A) megohmeter). 1 kHz dielectric characterizations (*C* and tan δ) were realized with a RCL meter Fluke PM 6306 between -45 and 145 °C (SECASI hot/cold oven with moisture rate regulated from 0 to 100% for temperatures higher than 10 °C).

3. Results

3.1. Sintering of $MgTiO_3 + Li$ compounds addition

We have discussed earlier the sintering of MgTiO₃ with different lithium sources⁸ Fig. 1 is an illustration of the sintering behavior of such compositions. Whatever the lithium source is, densification is easier than with pure MgTiO₃. It seems also that are exist two different behaviors: that of the lithium "oxides" with a dramatic lowering of the shrinkage rate close to 1100 °C, and that of the lithium halides characterized by a densification behavior without any accident. Yet, only LiF permits the densification of the ceramic at a temperature much lower than 1000 °C with a high dependence on the stoichiometry: the densification is all the easier if there is an excess of magnesium in the initial ilmenite phase.

X-ray diffraction analysis points out the existence of a secondary phase for which only two diffraction peaks are visible ($d_{hkl} = 0.878$ and 1.466 Å) always present when the material is sintered with a lithium halide addition, either LiF or LiCl, and never when sintered with a lithium "oxide". The



Fig. 1. sintering behavior of $MgTiO_3$ with Mg/Ti = 1.025 sintered with # lithium sources, lithium amount equal to 8.24 at%.



Fig. 2. Sintering behavior of stoichiometric MgTiO₃ with binary eutectics additions.

analysis of this phase pointed out that it contained magnesium but not any titanium.

In every case, the dielectric measurements of ceramics sintered in wet $(N_2 + 1\% H_2)$ are characteristic of MgTiO₃ dielectric materials. All resistivities at room temperature are higher than $10^{12} \Omega$ cm. Yet, these characteristics slightly degrade when lithium "oxides" are used, evidencing some conduction in the material although these ceramics possess much better insulation characteristics than pure MgTiO₃ sintered in oxygen at 1350 °C and heated again together with them in a reducing atmosphere.

These observations point out that, although Li alone has a strong effect on the sintering process, the presence of fluorine is necessary for the obtaining of an easy densification at low temperature. We have thus investigated on effect of fluorine compounds addition.

3.2. Sintering of $MgTiO_3$ + fluorine compounds addition

Phase diagrams of either the binary systems MgF_2-BaF_2 or MgF_2-CaF_2 and the ternary systems MgF_2-BaF_2-LiF or MgF₂-CaF₂-LiF show binary eutectics and large domains of compositions with low-melting temperatures.9 Binary eutectic composition composed of 43 at% CaF2 and 57 at% MgF_2 melts at 980° and the one composed of 60 at% BaF2 and 40 at% MgF2 at 912 °C (with, in this last diagram, the incongruent melting of Mg₂BaF₆ at 942 °C). Ternary eutectic composition 0.12CaF₂/0.28MgF₂/0.6LiF melts at 672 °C. Two ternary eutectics are observed in the composition diagram BaF2/MgF2/LiF respectively at 748 and 654 °C (this last one corresponding to the composition 0.256MgF₂/0.222BaF₂/0.522LiF) together with a ternary peritectic at 741 °C. Addition of such compounds to MgTiO₃ is thus attractive as they may allow a lower sintering temperature without any danger of the introduction of species detrimental to the electric and dielectric properties.

Dilatometric analysis of the sintering of stoichiometric magnesium titanate with either the CaF_2/MgF_2 or the BaF_2/MgF_2 eutectic (Fig. 2) shows effectively that densification is easier and occurs at a lower temperature than pure $MgTiO_3$. Although the dielectric characteristics and the value



Fig. 3. Sintering behavior of stoichiometric MgTiO₃ with ternary eutectics addition.

of the insulation resistance were compatible with the use in dielectric formulations when sintered in an oxidizing atmosphere, both the losses and the insulation resistance values showed some conduction and thus reduction of the material when it was sintered in wet $N_2 + 1\%$ H₂. It is noteworthy as well that the "unknown phase" appearing when lithium fluorine or chlorine were added alone is never detected in the present case.

The lower melting temperatures of the ternary eutectics compared to the equivalent binary eutectics (without LiF) are consistent with the densification occurring now at very low temperatures. It is noteworthy that only magnesium titanate, either stoechiometric or with an excess of magnesium, can be easily densified unlike to titanium excess compositions. The lowest densification temperatures, 840 °C for stoechiometric MgTiO₃ and 800 °C for Mg excess MgTiO₃, were observed with 5 wt% addition of the CaF₂/MgF₂/LiF eutectic (Fig. 3). This easier densification when CaF₂/MgF₂/LiF eutectic is added may appear surprising as its melting temperature ($672 \degree$ C) is intermediate between the melting temperature of the BaF₂/MgF₂/LiF eutectic ($654 \degree$ C) we attempted to add to MgTiO₃ and the one of the second ternary eutectic of this diagram (748 °C).

An important observation is that, whatever the ternary eutectic containing LiF and the Mg/Ti stoichiometry are, the presence of an already mentioned unidentified phase present when MgTiO₃ was sintered with either LiF or LiCl is also detected often together with MgO.

The dielectric characteristics of ceramics from both systems sintered in a reducing wet N₂/H₂ atmosphere are typical of type I dielectric capacitors with a dielectric constant close to 14 or 15, dielectric losses lower than 0.2% and insulation resistances higher than $10^{13} \Omega$ cm. Yet, the compositions including the BaF₂/MgF₂/LiF eutectic seem less attractive as the ceramics are characterized by a negative temperature coefficient that seems difficult to reduce to 0 value. Furthermore, a careful examination of the losses characteristic versus temperature shows that a slight increase of its value occurs at high temperatures (higher than $120 \,^{\circ}$ C). This particular behavior may be an indication of a slight electrical conduction in this case.

4. Discussion and conclusion

All these observations point out the evidence that the addition of some at% of an halide lithium compound, either chlorine or, better, fluorine, helps the densification at a low temperature of MgTiO₃ dielectric compositions. This temperature may be compatible with the co-sintering of the dielectric material with copper electrodes. Furthermore, the presence of both lithium and fluorine and/or chlorine is necessary to the ability for this dielectric composition to be sintered in a reducing atmosphere compatible with copper electrodes. They are consistent with the hypothesis of the following model explaining the densification process and the ability to sinter these materials in a reducing atmosphere.

When lithium is alone, it can introduce in the A site of the ilmenite and substitute magnesium. It helps first in the densification as it leads to the creation of oxygen vacancies to assure the electrical neutrality. Yet, due to the substitution of Mg by Li in the structure, magnesium oxide second phase appears that interferes with the densification process. As Li⁺ acts then as an acceptor, the material can be sintered in a reducing atmosphere without losing its insulation resistance characteristics.

When fluorine is present without lithium, the densification aid comes then from the presence of low-melting temperature eutectics, either BaF_2-MgF_2 or CaF_2-MgF_2 . The lower the eutectic melting temperature is, the lower the densification temperature is. Yet, as now no acceptor substitutes in the lattice, the insulation resistance is poor when the ceramic is sintered in a reducing atmosphere.

The sintering behavior appears as completely different when lithium is present together with a halide, either Cl⁻ or, better, F⁻. First, it seems that the lithium halide reacts with MgTiO₃ with the consequence of the appearance of a new phase with two reticular distances respectively $d_{hkl} = 0.878$ and 1.466 Å. This phase seems to have a structure very close to that of MgO but is quite independent of it as stated when these two compounds can be detected together. The composition of the unknown phase includes magnesium but not titanium. Thus, its appearance has at least two consequences: first, it helps at the evidence the densification at low temperature. Secondly, when it is present, lithium can substitute for magnesium and then act as an acceptor. It was shown that, after sintering, the ratio Mg/Ti was significantly lower to the one analyzed by EDS on the ilmenite grains before sintering or on ceramics sintered without lithium.¹⁰ Furthermore, in order to keep the electrical neutrality of the material, titanium Ti³⁺ reduces to Ti³⁺ that, thanks to its ionic radius, goes together with Li⁺ on the A site of the ilmenite with as a consequence the creation of acceptor/donor pairs that keep the material from reduction when sintered in a reducing atmosphere. The ilmenite can then be described by the following formula: $(Mg_{1-2x}^{2+}Li_x^{+}Ti_x^{3+})Ti^{4+}O_3.$

When Ca^{2+} is present, another substitution may occur: in the case of the addition of $CaTiO_3$ to $BaTiO_3$, it was demonstrated by D. Smyth and co-authors that, either the ionic radii were far to be the same, some amounts of Ca^{2+} ions substituted Ti^{4+} in the B site of the perovskite.¹¹ We can thus consider the hypothesis that, in the present case as well, Ca^{2+} substitutes Ti^{4+} , acting there as an acceptor. Thanks to the large ionic radii gap ($Ca^{2+} = 1$ Å when 6-coordinated) that leads to the appearance of some easier diffusion paths in the structure and, thus, to a slightly easier densification. Furthermore, that could explain the better insulation resistance of the $CaF_2/MgF_2/LiF$ eutectic added ceramics compared to the $BaF_2/MgF_2/LiF$ eutectic added one when sintered in a reducing atmosphere.

Acknowledgments

The results presented here were obtained with the support of TEMEX Company. We thank also the Europe Community for the financial support (FEDER Funds).

References

- Hennings, D., Dielectric ceramic material for multilayer capacitors with Ni electrodes. In CIMTEC 1998 Proceedings K1: IL06, p. 88.
- 2. Hennings, D., Dielectric materials for sintering in reducing atmospheres. J. Eur. Ceram. Soc., 2001, 21, 1637–1642.
- Kishi, H., Mizuno, Y. and Chazono, H., Base metal electrode multilayer ceramic capacitor: past, present and future perspectives. *Jpn. J. Appl. Phys.*, 2003, **42**, 1–15.
- Hagemann, H. J. and Hennings, D., Reversible weight change acceptor-doped BaTiO₃. J. Am. Ceram. Soc., 1981, 64(10), 590– 594.

- Albertsen, K., Hennings, D. and Steigelmann, O., Donor/acceptor charge complex formation, the role of firing atmospheres. *J. Electroceram.*, 1998, 2(3), 193–198.
- Vigreux, C., Deneuve, B., El Fallah, J. and Haussonne, J. M., Effects of acceptor and donor additives on the properties of MgTiO₃ ceramics sintered under reducing atmosphere. *J. Eur. Ceram. Soc.*, 2001, 21, 1681–1684.
- Haussonne, J. M. and Desgardin, G., Dielectric properties of barium titanate-based capacitors with lithium additions, "Dielectric Ceramic". *Am. Ceram. Soc. Ceram. Trans.*, 1993, **32**, 155–166.
- Bernard, J., Houivet, D., El Fallah, J. and Haussonne, J. M., MgTiO₃ for base metal multilayer ceramic capacitors. *J. Eur. Ceram. Soc.*, 2004, 24, 1877–1881.
- 9. Phase diagrams for ceramists, The American Ceramic Society. CaF_2/MgF_2 , no. 4820 vol. 3; BaF_2/MgF_2 , no. 1511 vol. 1; $CaF_2/MgF_2/LiF$, no. 1555 vol. 1; $BaF_2/MgF_2/LiF$, no. 1552 vol. 1.
- Haussonne, J. M., Type I base-metal electrode multilayer ceramic capacitors. In *Invited Conference at the 106ème Annual Meeting of* the American Ceramic Society, Indianapolis, Vol 157, 2004.
- 11. Han, Y. H., Appleby, J. B. and Smyth, D. M., J. Am. Ceram. Soc., 1987, 70, 96.